



AMP-HDI

TE Internal #: 533903-8

PCB Mount Header, Vertical, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black, Tube

[View on TE.com >](#)

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **100**

Number of Rows: **2**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	100
Number of Rows	2

Electrical Characteristics

Insulation Resistance	2 MΩ
-----------------------	------

Body Features

Primary Product Color	Black
-----------------------	-------

Contact Features

	.21 in
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Four Beam



PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	1.27 μm [50 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A

Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	4.83 mm[.19 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

PCB Mount Retention Type	Solder Tail
Mating Alignment	Without
Mating Alignment Type	Keyed
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic

Dimensions

Connector Height	11.73 mm[.462 in]
PCB Thickness (Recommended)	1.57 mm[1.27 in]

Usage Conditions

Housing Temperature Rating	High
Operating Temperature Range	-65 – 125 $^{\circ}\text{C}$ [-85 – 257 $^{\circ}\text{F}$]

Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal

Industry Standards

UL Flammability Rating	UL 94V-0
------------------------	----------

Packaging Features



Packaging Quantity	4
Packaging Method	Tube

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: DEC 2011 (71) SVHC > Threshold: Not Yet Reviewed
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts



Customers Also Bought



Documents

Product Drawings

[HDI Pin Assy 2 row 100 pos](#)

English

CAD Files

[3D PDF](#)

3D

Customer View Model

[ENG_CVM_CVM_533903-8_G.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_533903-8_G.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_533903-8_G.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

[Application Specification](#)

English

Instruction Sheets

[Instruction Sheet \(U.S.\)](#)

English

533903-8

PCB Mount Header, Vertical, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline,
Fully Shrouded, Gold, Through Hole - Solder, Signal, Black, Tube

